



# SPN138N08

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN138N08 is the N-Channel enhancement mode power field effect transistor which is produced using high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

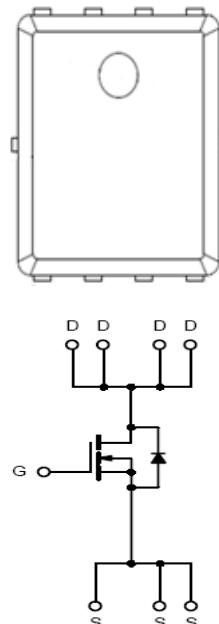
### FEATURES

- ◆ 80V/138A,RDS(ON)=3.6mΩ@VGS=10V
- ◆ Super high density cell design for extremely low Rds (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ PPAK5x6-8L package design

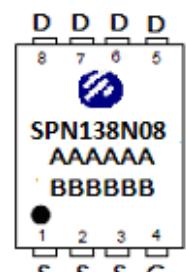
### APPLICATIONS

- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Power Tool
- Motor Control

### PIN CONFIGURATION (PPAK5x6-8L)



### PART MARKING



A : Lot Code  
B : Date Code  
(YY / MM / DD )



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### PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN138N08DN8RGB	PPAK5x6-8L	SPN138N08

※ SPN138N08DN8RGB : 13" Tape Reel ; Pb – Free ; Halogen – Free

### ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	80	V
Gate –Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current(Silicon Limited)	T <sub>C</sub> =25°C	138	A
	T <sub>C</sub> =100°C	88	
Pulsed Drain Current	I <sub>DM</sub>	400	A
Avalanche Energy with Single Pulse ( T <sub>C</sub> =25°C , L = 0.4mH )	E <sub>AS</sub>	320	mJ
Power Dissipation	T <sub>C</sub> =25°C	83	W
	T <sub>A</sub> =70°C	1.6	
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Case	R <sub>θJC</sub>	1.5	°C/W



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### ELECTRICAL CHARACTERISTICS

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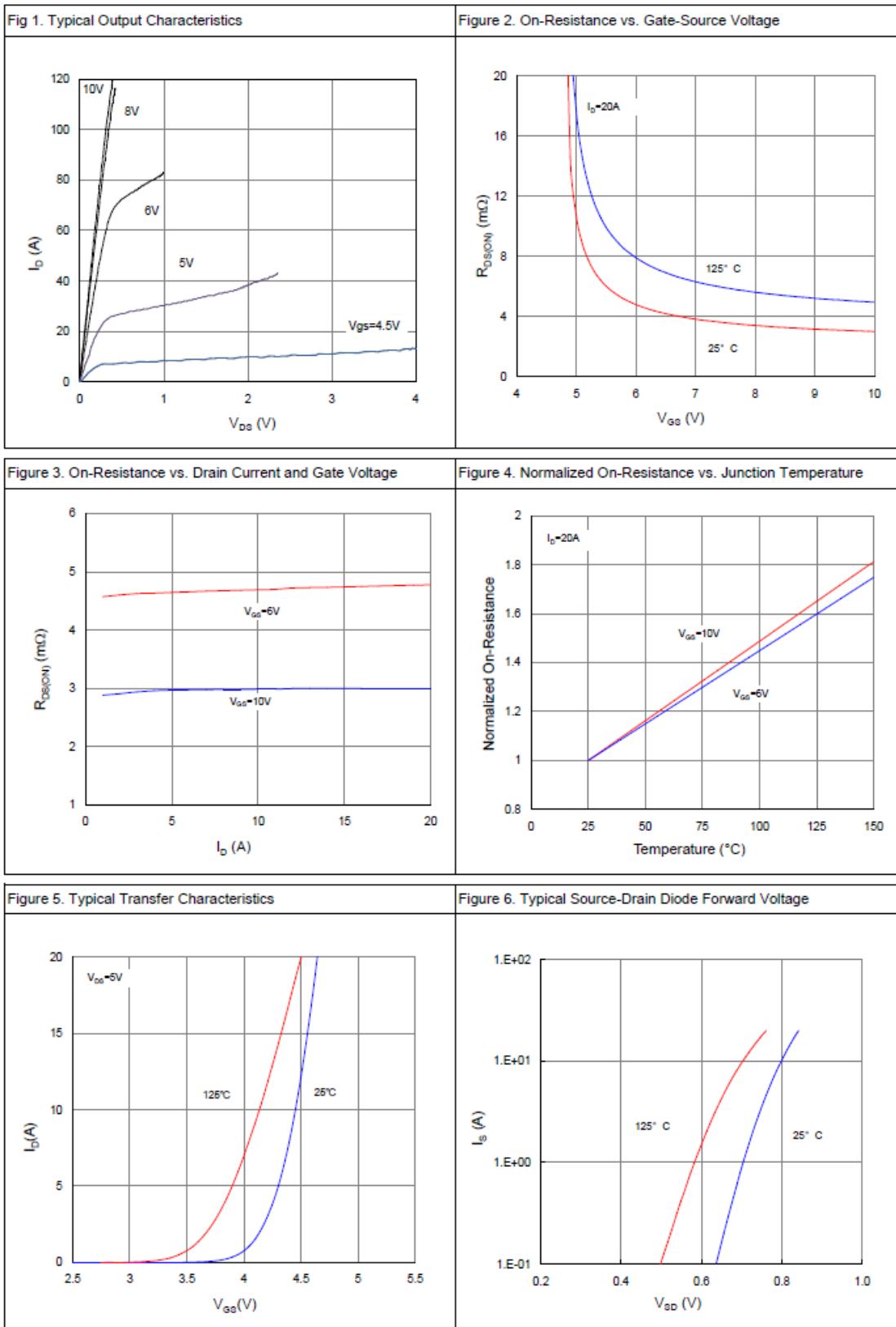
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	80			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.0		4.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V T <sub>J</sub> =25°C			1	uA
		V <sub>DS</sub> =80V, V <sub>GS</sub> =0V T <sub>J</sub> =100°C			100	
Drain-Source On-Resistance	R <sub>DSS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		3.0	3.5	mΩ
Forward Transconductance	g <sub>fS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =20A		64		S
Gate Resistance	R <sub>G</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =Open, f=1MHz		1.2		Ω
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =10V I <sub>D</sub> =20A		68		nC
Gate-Source Charge	Q <sub>gs</sub>			13		
Gate-Drain Charge	Q <sub>gd</sub>			17		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V f=1MHz		4350		pF
Output Capacitance	C <sub>oss</sub>			704		
Reverse Transfer Capacitance	C <sub>rss</sub>			28		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =40V, I <sub>D</sub> =20A, V <sub>GS</sub> =10V, R <sub>G</sub> =10Ω		16		nS
	t <sub>r</sub>			12		
Turn-Off Time	t <sub>d(off)</sub>			50		
	t <sub>r</sub>			19		
<b>Reverse Recovery</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =20A, V <sub>GS</sub> =0V		0.9	1.2	V
Reverse Recovery Time	T <sub>rr</sub>	V <sub>R</sub> =40I <sub>F</sub> =20A, dI <sub>F</sub> /dt=100A/uS		50		nS
Reverse Recovery Charge	Q <sub>rr</sub>			61		nC



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### TYPICAL CHARACTERISTICS

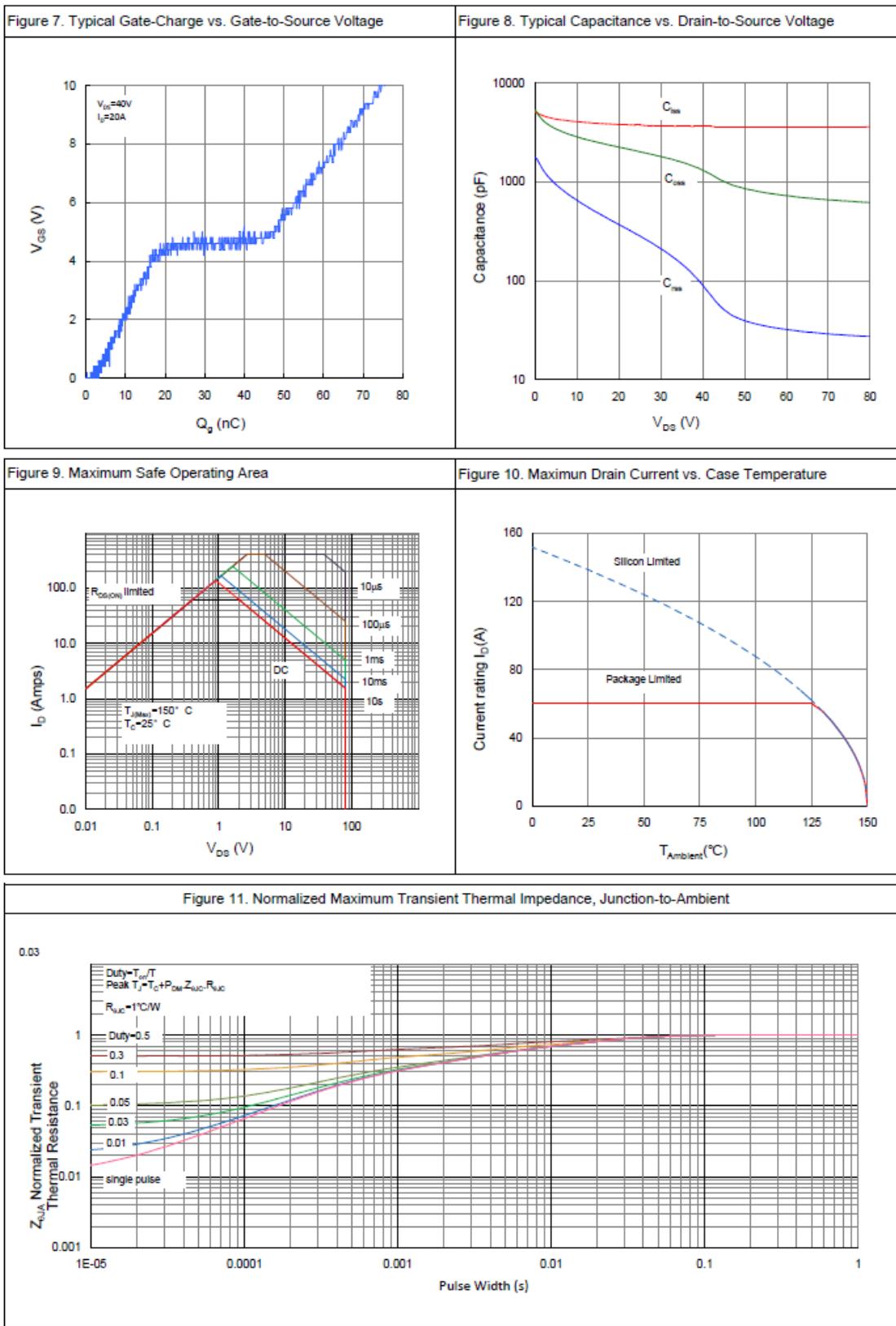




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### TYPICAL CHARACTERISTICS





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